74LVC161

Presettable synchronous 4-bit binary counter; asynchronous reset

Rev. 6 — 30 September 2013 Product data sheet

1. General description

The 74LVC161 is a synchronous presettable binary counter which features an internal look-ahead carry and can be used for high-speed counting. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (pin CP). The outputs (pins Q0 to Q3) of the counters may be preset to a HIGH-level or LOW-level. A LOW-level at the parallel enable input (pin $\overline{\text{PE}}$) disables the counting action and causes the data at the data inputs (pins D0 to D3) to be loaded into the counter on the positive-going edge of the clock (provided that the set-up and hold time requirements for PE are met). Preset takes place regardless of the levels at count enable inputs (pins CEP and CET). A LOW-level at the master reset input (pin $\overline{\text{MR}}$) sets all four outputs of the flip-flops (pins Q0 to Q3) to LOW-level regardless of the levels at input pins CP, $\overline{\text{PE}}$, CET and CEP (thus providing an asynchronous clear function).

The look-ahead carry simplifies serial cascading of the counters. Both count enable inputs (pin CEP and CET) must be HIGH to count. The CET input is fed forward to enable the terminal count output (pin TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH-level output of Q0. This pulse can be used to enable the next cascaded stage.

The maximum clock frequency for the cascaded counters is determined by t_{PHL} (propagation delay CP to TC) and t_{su} (set-up time CEP to CP) according to the formula:

$$f_{max} = \frac{1}{t_{PHL(max)} + t_{su}}$$

It is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Asynchronous reset
- Synchronous counting and loading
- Two count enable inputs for n-bit cascading
- Positive edge-triggered clock
- Complies with JEDEC standard:
    - JESD8-7A (1.65 V to 1.95 V)
    - JESD8-5A (2.3 V to 2.7 V)

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- JESD8-C/JESD36 (2.7 V to 3.6 V)
- Specified from –40 °C to +85 °C and –40 °C to +125 °C
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC161D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74LVC161DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74LVC161PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1
74LVC161BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1

4. Functional diagram

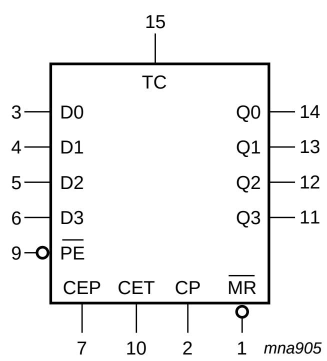


Fig 1. Logic symbol

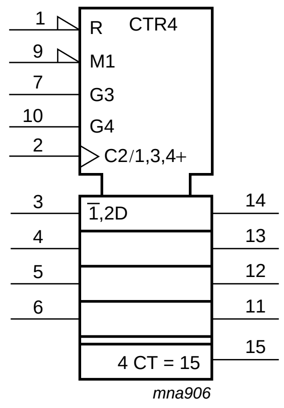


Fig 2. IEC logic symbol

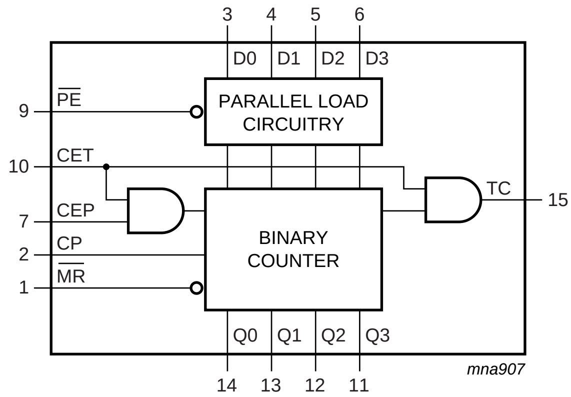


Fig 3. Functional diagram

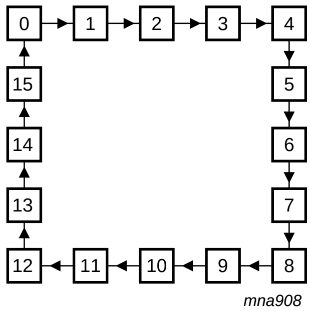


Fig 4. State diagram

5. Pinning information

5.1 Pinning

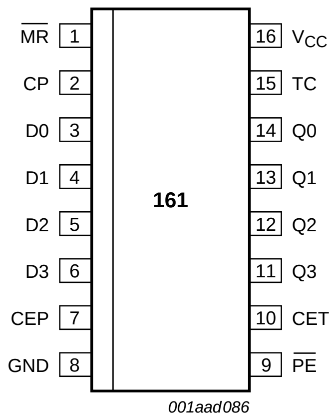
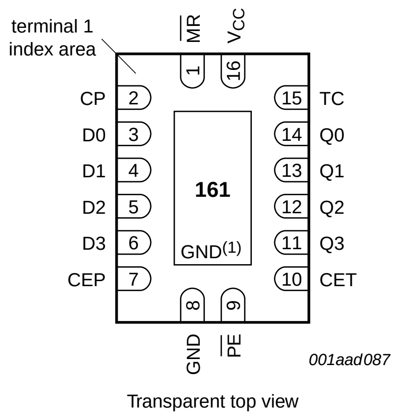


Fig 5. Pin configuration for SO16 and (T)SSOP16



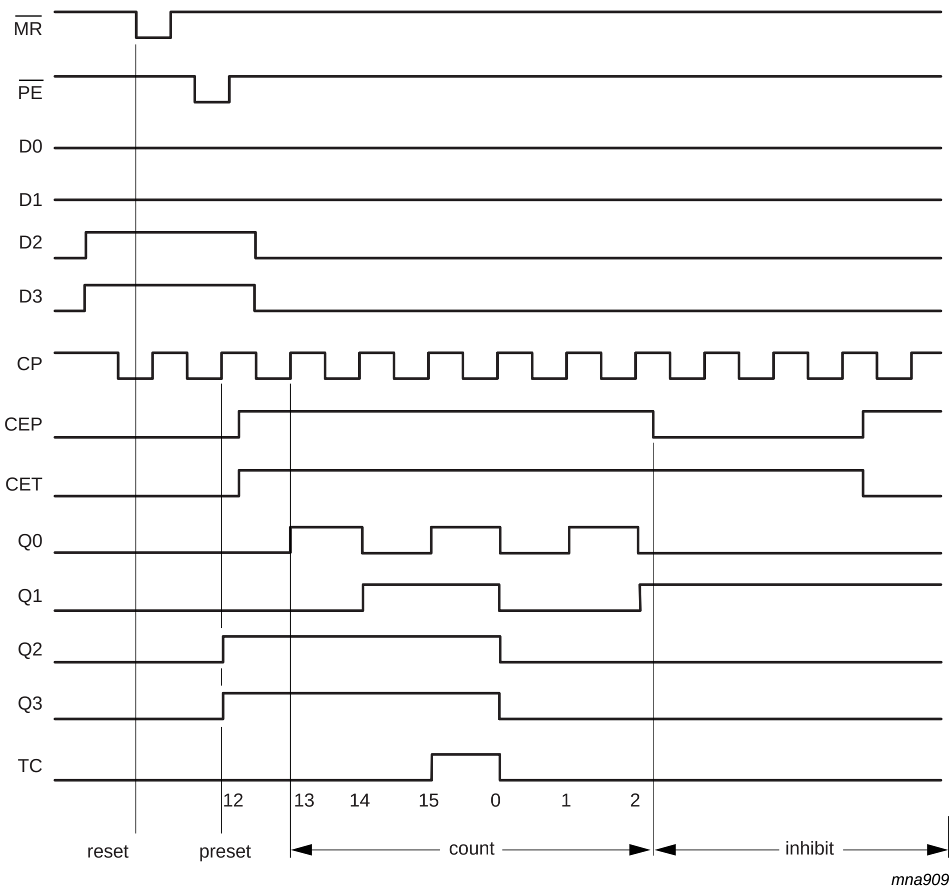
(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

Fig 6. Pin configuration for DHVQFN16

5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
$\overline{MR}$	1	synchronous master reset (active LOW)
CP	2	clock input (LOW-to-HIGH, edge-triggered)
D[0:3]	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
$\overline{PE}$	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q[0:3]	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V_{CC}	16	supply voltage



Typical timing sequence: reset outputs to zero; preset to binary twelve; count to thirteen, fourteen, fifteen, zero, one and two; inhibit.

Fig 7. Timing sequence

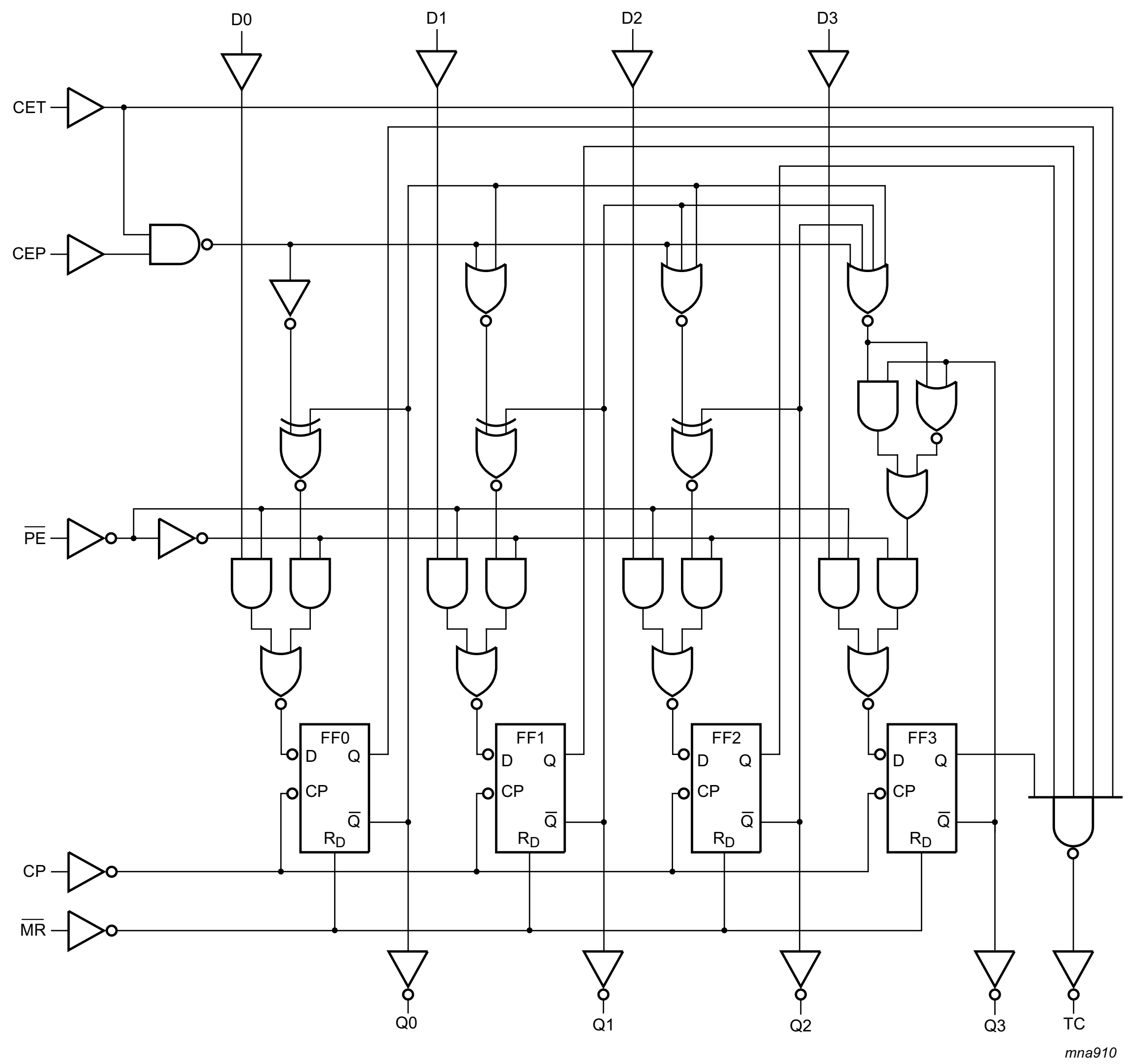


Fig 8. Logic diagram

6. Functional description

Table 3. Function table[1]

Operating modes	Input						Output	
	MR	CP	CEP	CET	$\overline{PE}$	Dn	Qn	TC
Reset (clear)	L	X	X	X	X	X	L	L
Parallel load	H	↑	X	X	l	l	L	L
	H	↑	X	X	l	h	H	*
Count	H	↑	h	h	h	X	count	*
Hold (do nothing)	H	X	l	X	h	X	q_n	*
	H	X	X	l	h	X	q_n	L

[1] * = the TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH)
H = HIGH voltage level
h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition
L = LOW voltage level
l = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition
q = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition
X = don't care
↑ = LOW-to-HIGH clock transition

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			–0.5	+6.5	V
I_{IK}	input clamping current	$V_I < 0$		–50	-	mA
V_I	input voltage		[1]	–0.5	+6.5	V
I_{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$		-	±50	mA
V_O	output voltage		[2]	–0.5	V_{CC} + 0.5	V
I_O	output current	V_O = 0 V to V_{CC}		-	±50	mA
I_{CC}	supply current			-	100	mA
I_{GND}	ground current			–100	-	mA
T_{stg}	storage temperature			–65	+150	°C
P_{tot}	total power dissipation	T_{amb} = –40 °C to +125 °C	[3]	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO16 packages: above 70 °C the value of P_D derates linearly with 8 mW/K.
For (T)SSOP16 packages: above 60 °C the value of P_D derates linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C the value of P_D derates linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature	in free air	−40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	−40 °C to +85 °C			−40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V_{IH}	HIGH-level input voltage	V_{CC} = 1.2 V	1.08	-	-	1.08	-	V
		V_{CC} = 1.65 V to 1.95 V	0.65 × V_{CC}	-	-	0.65 × V_{CC}	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 1.2 V	-	-	0.12	-	0.12	V
		V_{CC} = 1.65 V to 1.95 V	-	-	0.35 × V_{CC}	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}						
		I_O = −100 μA; V_{CC} = 1.65 V to 3.6 V	V_{CC} − 0.2	-	-	V_{CC} − 0.3	-	V
		I_O = −4 mA; V_{CC} = 1.65 V	1.2	-	-	1.05	-	V
		I_O = −8 mA; V_{CC} = 2.3 V	1.8	-	-	1.65	-	V
		I_O = −12 mA; V_{CC} = 2.7 V	2.2	-	-	2.05	-	V
		I_O = −18 mA; V_{CC} = 3.0 V	2.4	-	-	2.25	-	V
		I_O = −24 mA; V_{CC} = 3.0 V	2.2	-	-	2.0	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}						
		I_O = 100 μA; V_{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		I_O = 4 mA; V_{CC} = 1.65 V	-	-	0.45	-	0.65	V
		I_O = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V
		I_O = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		I_O = 24 mA; V_{CC} = 3.0 V	-	-	0.55	-	0.8	V
I_I	input leakage current	V_{CC} = 3.6 V; V_I = 5.5 V or GND	-	±0.1	±5	-	±20	μA

Table 6. Static characteristics *…continued*

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	−40 °C to +85 °C			−40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
I_{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	10	-	40	μA
ΔI_{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_I = V_{CC} − 0.6 V; I_O = 0 A	-	5	500	-	5000	μA
C_I	input capacitance	V_{CC} = 0 V to 3.6 V; V_I = GND to V_{CC}	-	5.0	-	-	-	pF

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 14.

Symbol	Parameter	Conditions		−40 °C to +85 °C			−40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t_{pd}	propagation delay	CP to Qn; see Figure 9	[2]						
		V_{CC} = 1.2 V		-	17	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	7.0	14.5	1.5	16.7	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	4.0	8.1	2.5	9.4	ns
		V_{CC} = 2.7 V		1.5	3.8	7.2	1.5	9.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.6	7.3	1.5	9.5	ns
		CP to TC; see Figure 9	[2]						
		V_{CC} = 1.2 V		-	20	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.8	8.1	15.5	1.8	17.9	ns
		V_{CC} = 2.3 V to 2.7 V		2.8	4.6	8.7	2.8	10.1	ns
		V_{CC} = 2.7 V		1.5	4.3	7.8	1.5	10.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	4.2	7.8	1.5	10.0	ns
		CET to TC; see Figure 10	[2]						
		V_{CC} = 1.2 V		-	16	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	5.9	11.9	1.5	13.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.9	3.4	6.7	1.9	7.7	ns
		V_{CC} = 2.7 V		1.5	3.6	6.5	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.1	6.0	1.5	7.5	ns

Table 7. Dynamic characteristics *...continued*

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 14.

Symbol	Parameter	Conditions	−40 °C to +85 °C			−40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t_{PHL}	HIGH to LOW propagation delay	$\overline{MR}$ to Qn; see Figure 11						
		V_{CC} = 1.2 V	-	17	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V	1.5	6.2	12.7	1.5	14.6	ns
		V_{CC} = 2.3 V to 2.7 V	1.9	3.6	7.1	1.9	8.3	ns
		V_{CC} = 2.7 V	1.5	3.9	7.1	1.5	9.0	ns
		V_{CC} = 3.0 V to 3.6 V	1.5	3.2	6.4	1.5	8.0	ns
		$\overline{MR}$ to TC; see Figure 11						
		V_{CC} = 1.2 V	-	18	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V	1.7	8.3	15.9	1.7	18.4	ns
		V_{CC} = 2.3 V to 2.7 V	2.7	4.8	8.9	2.7	10.3	ns
		V_{CC} = 2.7 V	1.5	4.9	8.6	1.5	11.0	ns
		V_{CC} = 3.0 V to 3.6 V	1.5	4.3	8.0	1.5	10.0	ns
t_W	pulse width	clock HIGH or LOW; see Figure 9						
		V_{CC} = 1.65 V to 1.95 V	6.0	-	-	6.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	5.0	-	-	5.0	-	ns
		V_{CC} = 2.7 V	5.0	-	-	5.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	4.0	1.2	-	4.0	-	ns
		master reset LOW; see Figure 11						
		V_{CC} = 1.65 V to 1.95 V	5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	4.0	-	-	4.0	-	ns
		V_{CC} = 2.7 V	4.0	-	-	4.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	3.0	1.6	-	3.0	-	ns
t_{rec}	recovery time	$\overline{MR}$ to CP; see Figure 11						
		V_{CC} = 1.65 V to 1.95 V	1.0	-	-	1.0	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	-	-	1.0	-	ns
		V_{CC} = 2.7 V	0.0	-	-	0.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	0.5	0.0	-	0.5	-	ns

Table 7. Dynamic characteristics *...continued*
Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 14.

Symbol	Parameter	Conditions		−40 °C to +85 °C			−40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t_{su}	set-up time	Dn to CP; see Figure 12							
		V_{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		V_{CC} = 2.7 V		3.0	-	-	3.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		2.5	1.0	-	2.5	-	ns
		$\overline{PE}$ to CP; see Figure 12							
		V_{CC} = 1.65 V to 1.95 V		4.5	-	-	4.5	-	ns
		V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		V_{CC} = 2.7 V		3.5	-	-	3.5	-	ns
		V_{CC} = 3.0 V to 3.6 V		3.0	1.2	-	3.0	-	ns
		CEP, CET to CP; see Figure 13							
		V_{CC} = 1.65 V to 1.95 V		8.0	-	-	8.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		6.0	-	-	6.0	-	ns
		V_{CC} = 2.7 V		5.5	-	-	5.5	-	ns
		V_{CC} = 3.0 V to 3.6 V		5.0	2.1	-	5.0	-	ns
t_h	hold time	Dn, $\overline{PE}$, CEP, CET to CP; see Figure 12 and 13							
		V_{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		V_{CC} = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		V_{CC} = 2.7 V		0.0	-	-	0.0	-	ns
		V_{CC} = 3.0 V to 3.6 V		0.5	0.0	-	0.5	-	ns
f_{max}	maximum frequency	see Figure 9							
		V_{CC} = 1.65 V to 1.95 V		100	-	-	80	-	MHZ
		V_{CC} = 2.3 V to 2.7 V		125	-	-	100	-	MHZ
		V_{CC} = 2.7 V		150	-	-	120	-	MHz
		V_{CC} = 3.0 V to 3.6 V		150	200	-	120	-	MHz
$t_{sk(o)}$	output skew time	V_{CC} = 3.0 V to 3.6 V	[3]	-	-	1.0	-	1.5	ns
C_{PD}	power dissipation capacitance	per input; V_I = GND to V_{CC}	[4]						
		V_{CC} = 1.65 V to 1.95 V		-	11.1	-			pF
		V_{CC} = 2.3 V to 2.7 V		-	14.7	-			pF
		V_{CC} = 3.0 V to 3.6 V		-	17.9	-			pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz; f_o = output frequency in MHz

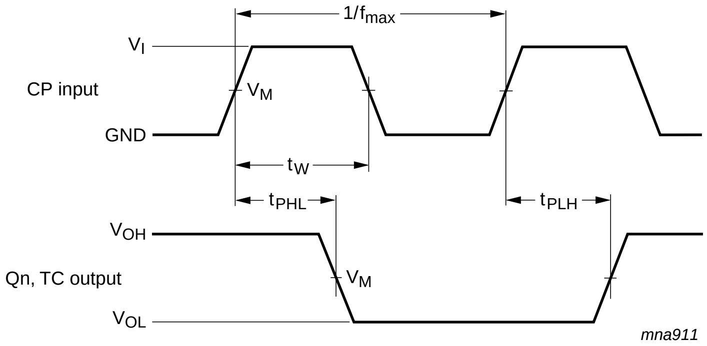
C_L = output load capacitance in pF

V_{CC} = supply voltage in V

N = number of inputs switching

$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs

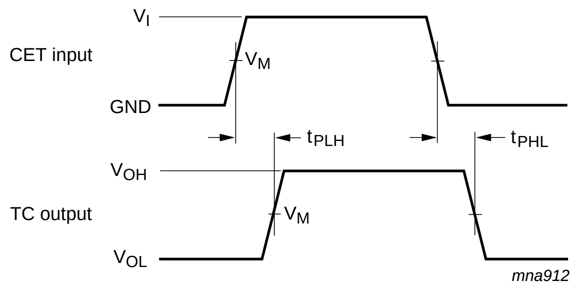
11. Waveforms



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 9. Clock (CP) to outputs (Qn, TC) propagation delays, the clock pulse width, and maximum frequency



Measurement points are given in Table 8.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 10. Input (CET) to output (TC) propagation delays

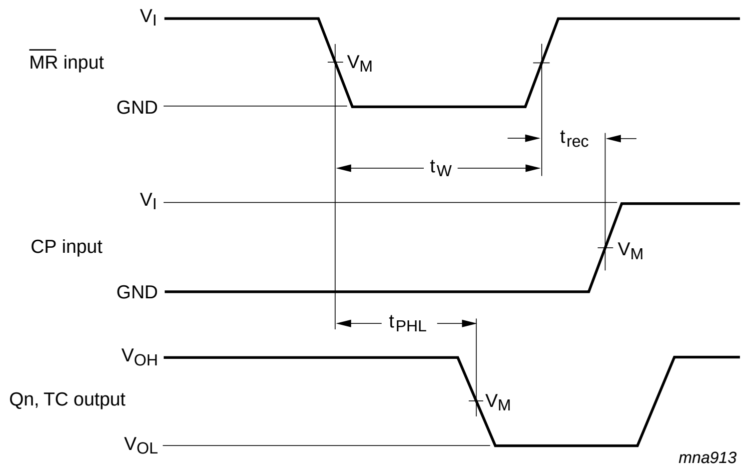
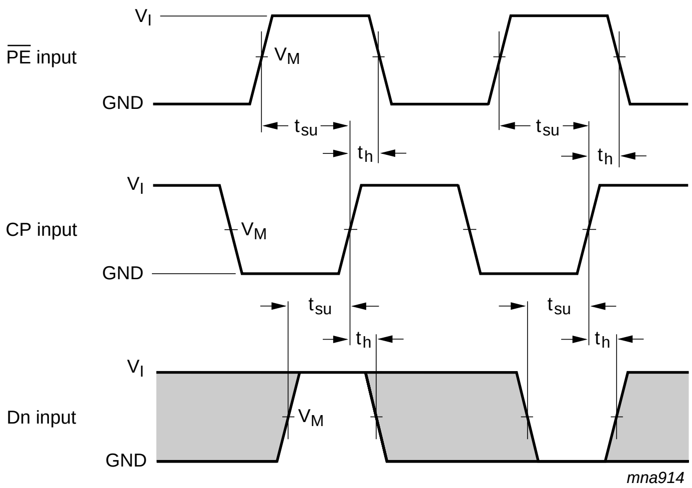
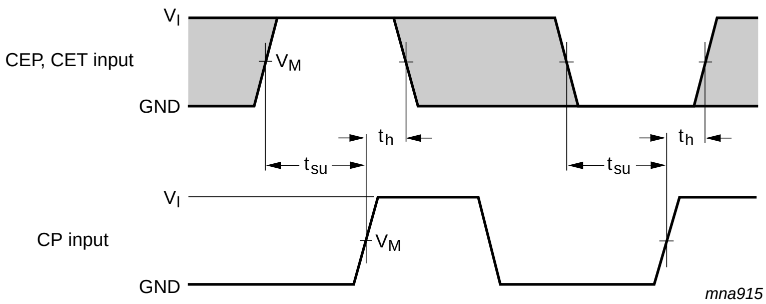


Fig 11. Master reset ($\overline{MR}$) pulse width, the master reset to output (Qn, TC) propagation delays, and the master reset to clock (CP) removal times



The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig 12. Set-up and hold times for the input (Dn) and parallel enable input ($\overline{PE}$)

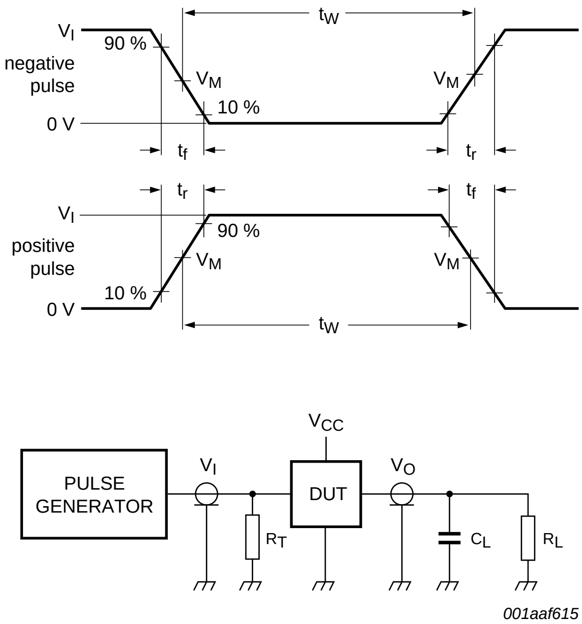


The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig 13. CEP and CET set-up and hold times

Table 8. Measurement points

Supply voltage	Input		Output
V_{CC}	V_I	V_M	V_M
1.2 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
1.65 V to 1.95 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.3 V to 2.7 V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V



Test data is given in Table 9. Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

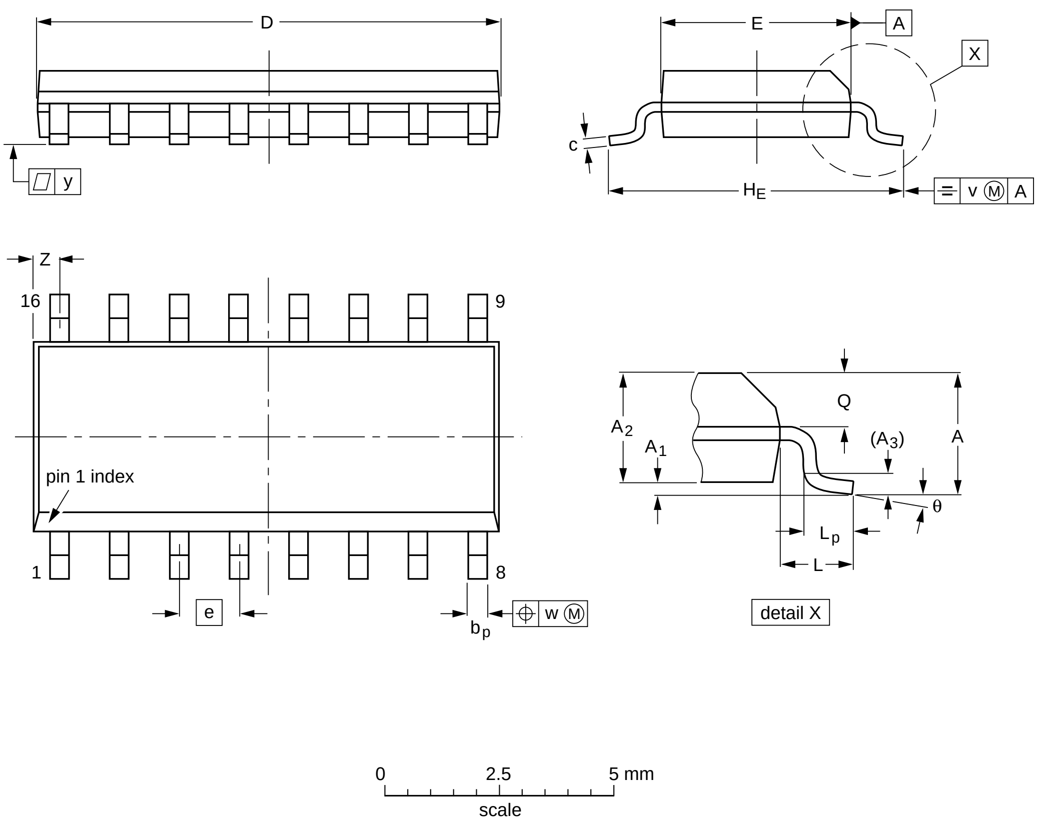
Fig 14. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input		Load	
	V_I	t_r, t_f	C_L	R_L
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500 Ω
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm **SOT109-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^o 0^o
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

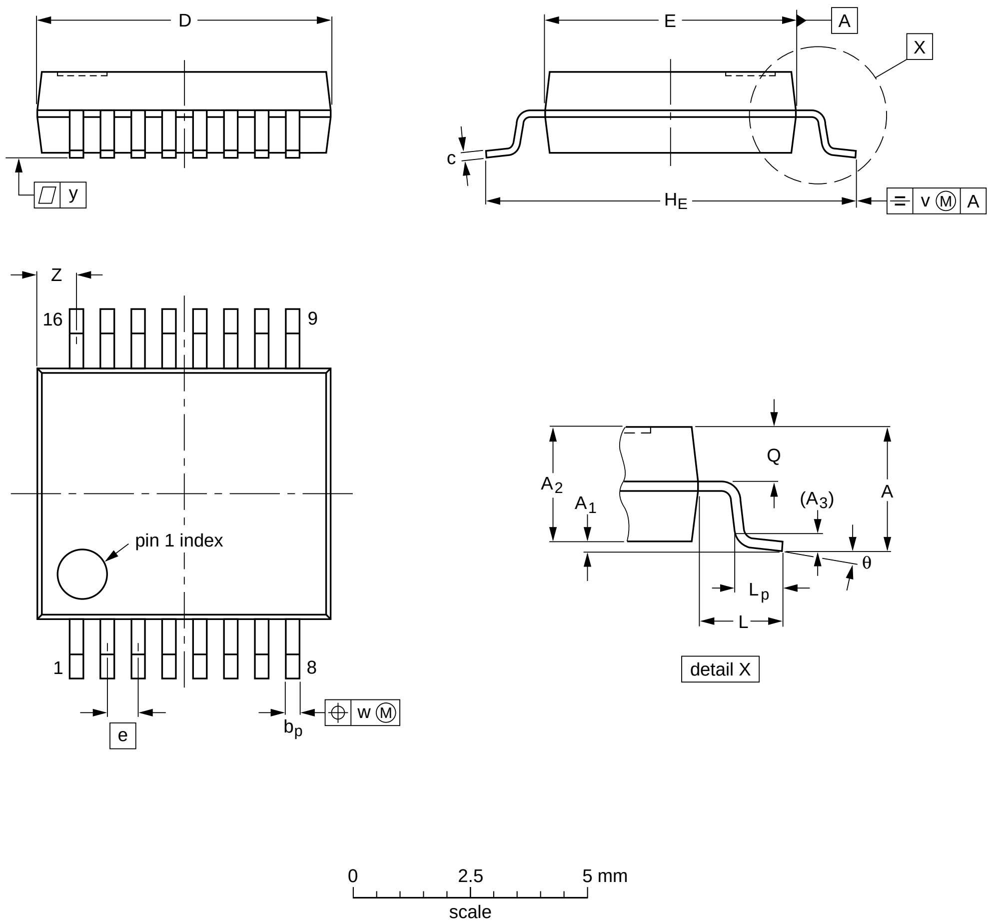
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT109-1	076E07	MS-012				~~99-12-27~~ 03-02-19

Fig 15. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm **SOT338-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8^o 0^o

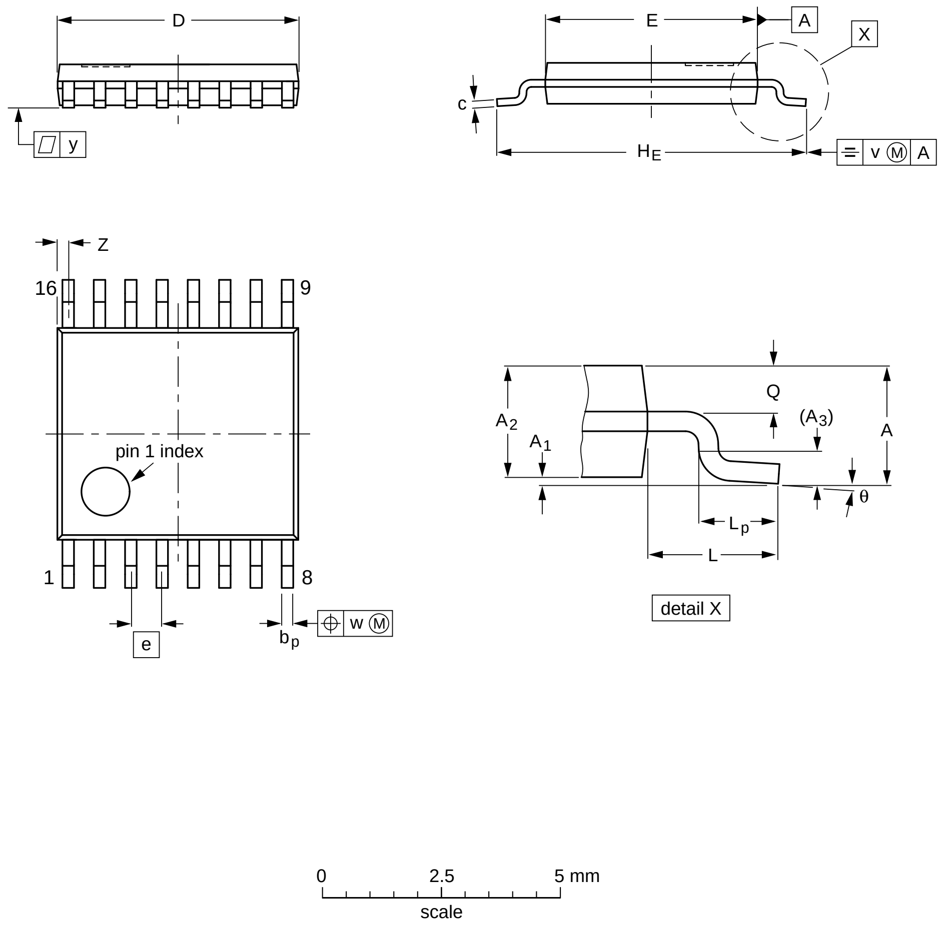
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT338-1		MO-150				~~99-12-27~~ 03-02-19

Fig 16. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm **SOT403-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8^o 0^o

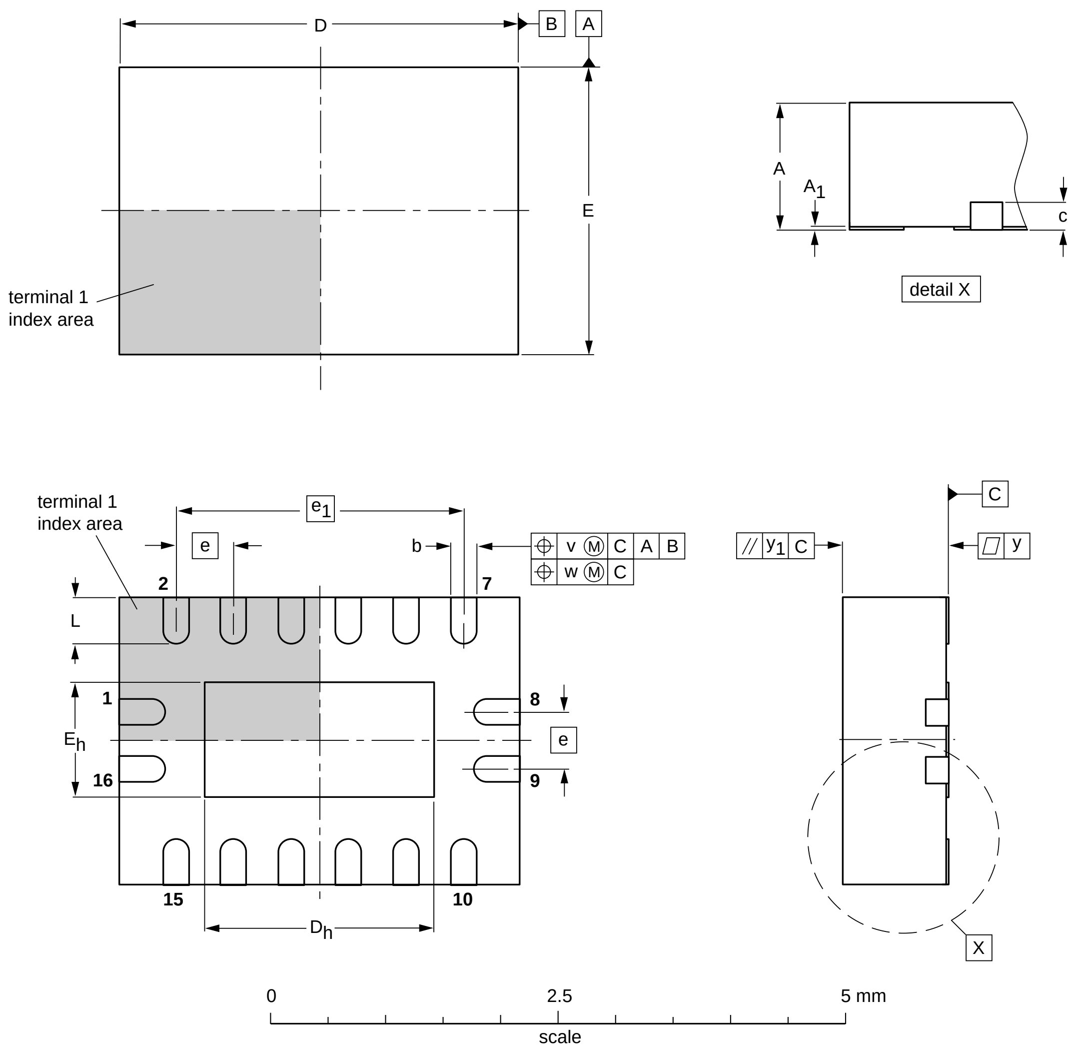
Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT403-1		MO-153				~~99-12-27~~ 03-02-18

Fig 17. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm **SOT763-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A(1) max.	A_1	b	c	D(1)	D_h	E(1)	E_h	e	e_1	L	v	w	y	y_1
mm	1	0.05 0.00	0.30 0.18	0.2	3.6 3.4	2.15 1.85	2.6 2.4	1.15 0.85	0.5	2.5	0.5 0.3	0.1	0.05	0.05	0.1

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT763-1	- - -	MO-241	- - -			~~02-10-17~~ 03-01-27

Fig 18. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC161 v.6	20130930	Product data sheet	-	74LVC161 v.5
Modifications:	• Figure 8 corrected (errata).			
74LVC161 v.5	20121123	Product data sheet	-	74LVC161 v.4
74LVC161 v.4	20121122	Product data sheet	-	74LVC161 v.3
74LVC161 v.3	20040330	Product specification	-	74LVC161 v.2
74LVC161 v.2	19980520	Product specification	-	74LVC161 v.1
74LVC161 v.1	19960823	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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17. Contents

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Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru

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